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| PATENT ASSIGNMENT COVER SHEET |
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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| GREGOR MÜLLER | 11/03/2021 |
| RECEIVING PARTY DATA | |
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| Postal Code: | 91074 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 17613108 |
| CORRESPONDENCE DATA | |
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| ATTORNEY DOCKET NUMBER: | P190636 WO-US |
| NAME OF SUBMITTER: | LEKEISHA M. SUGGS |
| SIGNATURE: | /LeKeisha M. Suggs/ |
| DATE SIGNED: | 11/22/2021 |
| This document serves as an Oath/Declaration (37 CFR 1.63). | |
| Total Attachments: 1 | |
| source=Assignment_Declaration_Muller#page1.tif | |

ASSIGNMENT AND DECLARATION UNDER 37 C.F.R. § 1.63
(For Use with Signed Application Data Sheet)

Title of Invention: POWER ELECTRONICS UNIT HAVING AT LEAST ONE SEMICONDUCTOR MODULE ATTACHED BY MEANS OF A PLASTIC HOLDER

Attorney Docket No.: P190636 WO-US

This assignment and declaration are directed to (check one):

- the attached application;
- the application identified by the attorney docket no. and title of invention given above;
- United States Application or PCT International Application No. _____, filed _____.

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, as a below-named inventor I have sold and assigned, and hereby sell and assign, to:

Name of Assignee: Schaeffler Technologies AG & Co. KG
Address of Assignee: Industriestraße 1-3, Herzogenaurach, Germany 91074

(hereinafter ASSIGNEE) all right, title, and interest in and to the above-identified invention and United States patent application, including: (i) any and all divisions or continuations thereof, and in and to any and all Letters Patent of the United States that may issue on any such application or for said invention, including any and all reissues or extensions thereof, to be held and enjoyed by said ASSIGNEE, its successors, or assigns to the full end of the term or terms for which any and all such Letters Patent may be granted; (ii) all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable, to be held and enjoyed by said ASSIGNEE, its successors, or assigns to the full end of the term or terms for which any and all such patents, utility models, designs or other rights may be granted; and (iii) all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof, to be held and enjoyed by said ASSIGNEE, its successors, or assigns to the full end of the term or terms for which any and all such patents, utility models, designs or other rights may be granted.

I hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue any and all such Letters Patent to said ASSIGNEE, its successors, or assigns in accordance herewith.

I warrant and covenant that I have the right to sell and assign the interests herein sold and assigned and that I have not executed and will not execute any document or instrument in conflict herewith.

I further covenant and agree that I will communicate to said ASSIGNEE, its successors, legal representatives, or assigns all information known to me relating to said invention or patent application and that I will execute and deliver any papers, make all rightful oaths, testify in any legal proceedings, and perform all other lawful acts necessary or desirable by said ASSIGNEE, its successors, legal representatives, or assigns to perfect title to said invention, to said application including divisions and continuations thereof and to any and all Letters Patent that may be granted therefor or thereon, including reissues or extensions, in said ASSIGNEE, its successors, or assigns, or to assist said ASSIGNEE, its successors, legal representatives, or assigns in obtaining, reissuing, or enforcing Letters Patent of the United States and any and all patents, utility models, designs or other rights that may be granted in the United States or of any country or countries foreign to the United States, for said invention.


DECLARATION

As a below-named inventor, I hereby declare that:

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

Inventor: Gregor Müller
Signature:  Date: 03.11.2021